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### STTH1R06

### Turbo 2 ultrafast high voltage rectifier

#### **Features**

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching and conduction losses

#### **Description**

The STTH1R06, which is using ST Turbo 2 600 V technology, is specially suited as boost diode in power factor correction circuitry.

The device is also intended for use as a free wheeling diode in power supplies and other power switching applications.

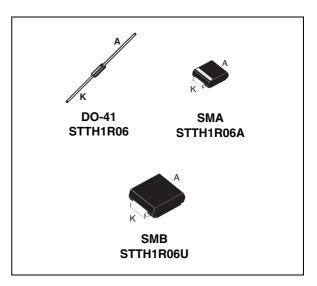


Table 1. Device summary

Symbol	Value
I <sub>F(AV)</sub>	1 A
V <sub>RRM</sub>	600 V
I <sub>R</sub> (max)	75 µA
T <sub>j</sub>	175 °C
V <sub>F</sub> (typ)	1.0 V
t <sub>rr</sub> (max)	25 ns

Characteristics STTH1R06

#### 1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Param	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage			600	V
	Forward rms current	DO-41		10	Α
I <sub>F</sub> (RMS)	Polward mis current	SMA / SMB		7	A
		DO-41	$T_{c} = 100  ^{\circ}\text{C}  \delta = 0.5$		
I <sub>F(AV)</sub>	Average forward current	SMA	$T_c = 125  ^{\circ}\text{C}  \delta = 0.5$	1	Α
			$T_c = 135  ^{\circ}\text{C}  \delta = 0.5$		
	Surge non repetitive femuera current	DO-41	t _ 10ma ainuaaidal	25	Α
'FSM	I <sub>FSM</sub> Surge non repetitive forward current		t <sub>p</sub> = 10ms sinusoidal	20	A
T <sub>stg</sub>	Storage temperature range	-65 to + 175	°C		
T <sub>j</sub>	Maximum operating junction temperature				°C

Table 3. Thermal resistance

Symbol	Parameter			Value (max)	Unit
		L = 10 mm	DO-41	45	
R <sub>th(j-l)</sub>	Junction to lead		SMA	30	°C/W
			SMB	25	
R <sub>th(j-a)</sub>	Junction to ambient <sup>(1)</sup>	L = 10 mm	DO-41	70	°C/W

<sup>1.</sup>  $R_{th(j-a)}$  is measured with a copper area S = Scm2 (see *Figure 14*).

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	$T_j = 25  ^{\circ}\text{C}$				1		
'R	I <sub>R</sub> Reverse leakage current	T <sub>j</sub> = 150 °C	$V_R = V_{RRM}$		10	75	μΑ
V	Forward voltage drap	T <sub>j</sub> = 25 °C	I = 1A			1.7	V
٧F	V <sub>F</sub> Forward voltage drop		I <sub>F</sub> = 1A		1.0	1.25	V

To evaluate the conduction losses use the following equation: P = 1.03 x  $I_{F(AV)}$  + 0.27  $I_{F}^{2}$  (RMS)

STTH1R06 Characteristics

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
+	Reverse recovery	T <sub>i</sub> = 25 °C	$I_F = 0.5A$ $I_{rr} = 0.25A$ $I_R = 1A$			25	ns
t <sub>rr</sub>	time	$I_j = 25$ C	$I_F = 1A dI_F/dt = -50 A/\mu s V_R = 30V$		30	45	115
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25 °C	$I_F = 1A \qquad dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$			100	ns
V <sub>FP</sub>	Forward recovery voltage	T <sub>j</sub> = 25 °C	$I_F = 1A$ $dI_F/dt = 100 A/\mu s$ $V_{FR} = 1.1 x V_{Fmax}$			10	V

Figure 1. Conduction losses versus average Figure 2. Forward voltage drop vs forward current current

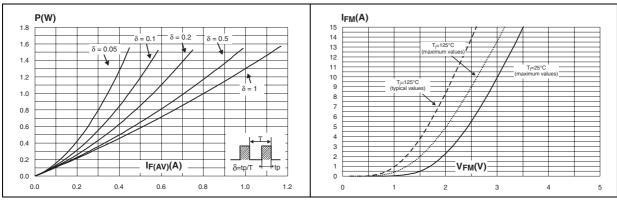
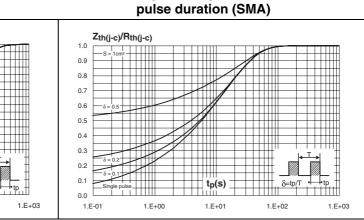


Figure 4.

Figure 3. Relative variation of thermal impedance junction to case vs pulse duration (DO-41)



**Relative variation of thermal** 

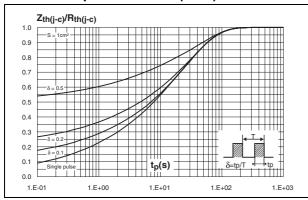
impedance junction to case vs

 $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.1 δ=tp/T 0.0 1.E-01 1.E+00 1.E+01 1.E+02

Characteristics STTH1R06

Figure 5. Relative variation of thermal impedance junction to case vs pulse duration (SMB)

Figure 6. Peak reverse recovery current vs dl<sub>F</sub>/dt (typical values)



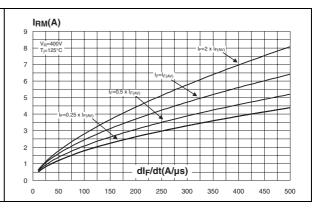
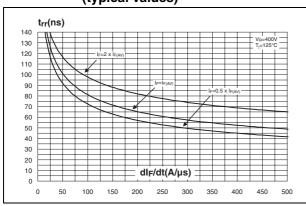


Figure 7. Reverse recovery time versus dl<sub>F</sub>/dt Figure 8. Reverse recovery charges versus (typical values)



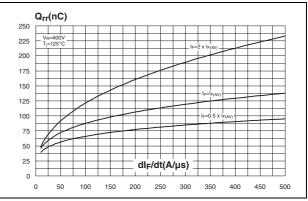
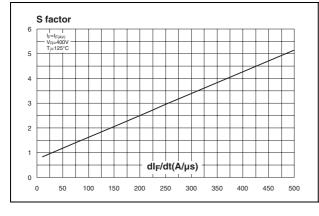
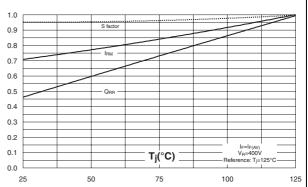


Figure 9. Reverse recovery softness factor vs dl<sub>F</sub>/dt (typical values)

Figure 10. Relative variations of dynamic parameters vs junction temperature





STTH1R06 Characteristics

Figure 11. Transient peak forward voltage vs Figure 12. Forward recovery time vs  $dl_F/dt$  (typical values) (typical values)

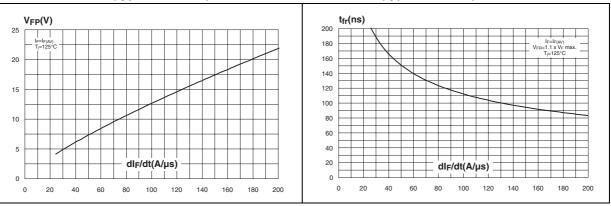


Figure 13. Junction capacitance versus reverse voltage applied (typical values)

Figure 14. Thermal resistance junction to ambient versus copper surface under each lead

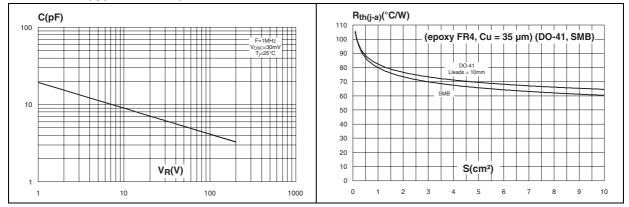
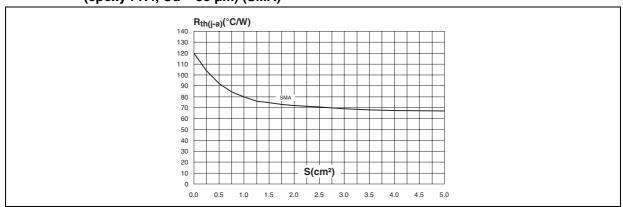


Figure 15. Thermal resistance junction to ambient versus copper surface under each lead (epoxy FR4, Cu = 35  $\mu$ m) (SMA)



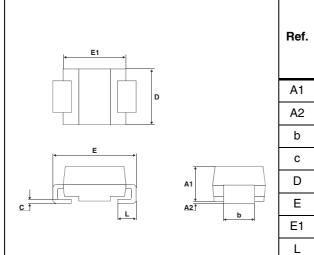
Package information STTH1R06

#### 2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. SMA dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.075	0.094		
A2	0.05	0.20	0.002	0.008		
b	1.25	1.65	0.049	0.065		
С	0.15	0.40	0.006	0.016		
D	2.25	2.90	0.089	0.114		
Е	4.80	5.35	0.189	0.211		
E1	3.95	4.60	0.156	0.181		
L	0.75	1.50	0.030	0.059		

Figure 16. Footprint (dimensions in mm)

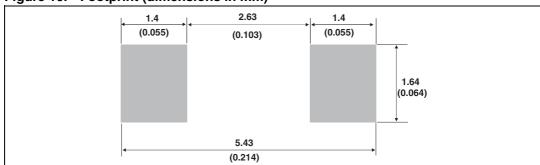
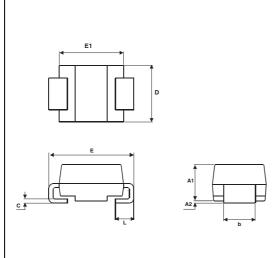


Table 7. SMB dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.075	0.096		
A2	0.05	0.20	0.002	0.008		
b	1.95	2.20	0.077	0.087		
С	0.15	0.40	0.006	0.016		
Е	5.10	5.60	0.201	0.220		
E1	4.05	4.60	0.159	0.181		
D	3.30	3.95	0.130	0.156		
L	0.75	1.50	0.030	0.059		

Figure 17. Footprint (dimensions in mm)

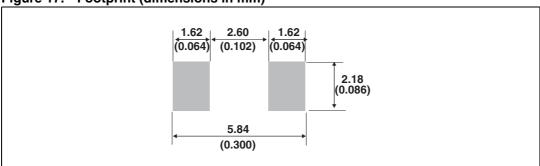
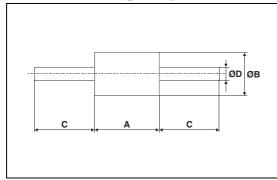


Table 8. DO-41 (plastic) dimensions



	Dimensions				
Ref.	Millin	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.07	5.20	0.160	0.205	
В	2.04	2.71	0.080	0.107	
С	25.4		1		
D	0.71	0.86	0.028	0.034	

Ordering information STTH1R06

## **3** Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH1R06	STTH1R06	DO-41	0.34 g	2000	Ammopack
STTH1R06RL	STTH1R06	DO-41	0.34 g	5000	Tape and reel
STTH1R06A	HR6	SMA	0.068 g	5000	Tape and reel
STTH1R06U	BR6	SMB	0.11 g	2500	Tape and reel

### 4 Revision history

Table 10. Document revision history

Date	Date Revision Changes			
Apr-2003	1	First issue.		
07-Sep-2004	DO-41 and SMA packages added.			
24-Feb-2005	3	SMA package dimensions update. Reference A1 max. changed from 2.70 mm (0.106 inc.) to 2.03 mm (0.080).		
02-Jul-2007	4	Reformatted to current standards. Added cathode bars to cover illustrations. Updated dimensions and footprint illustrations for SMA and SMB packages. Corrected part number in Table 9.		
30-Sep-2009	5	Updated table 8 package dimensions.		

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